EE 551 Linear Integrated Circuits Homework 2

Silicon material parameters to be used in this homework set.

 $\begin{array}{c} n_i = 10^{10} \text{cm}^{-3}, \ \mu_n = 1360 \text{cm}^2/\text{Vs}, \ \mu_p = 460 \text{cm}^2/\text{Vs}, \ \tau_n = \tau_p = 100 \mu\text{s}, \ \text{E}_g = 1.12 \text{eV}, \\ K_s = 11.8, \ \epsilon_0 = 8.854 \text{x} 10^{-12} \text{F/m}, \ T = 300 \text{K}, \ n = 1 \end{array}$

- 1. A piece of n-type silicon is doped with $N_D = 2x10^{16} \text{ cm}^{-3}$.
 - a. What is the probability of finding a hole in the valence band?
 - b. What is the probability of finding an electron in the valence band?
 - c. What is the probability of finding an electron 0.1meV above the conduction band?
 - d. What is the probability of finding a hole in the conduction band?
- 2. Use the band diagram for silicon for the following parts of this problem.



- a. Is this n-type or p-type material? Why?
- b. What is the majority carrier and the majority carrier concentration?
- c. What is the minority carrier and the minority carrier concentration?
- d. What is the resistivity of this material?
- 3. A silicon cube (2mm on each side) has been doped with $N_D = 1 \times 10^{16} \text{ cm}^{-3}$ and $N_A = 5 \times 10^{16} \text{ cm}^{-3}$.
 - a. Is this n-type or p-type material? Why?
 - b. What is the majority carrier and the majority carrier concentration?
 - c. What is the minority carrier and the minority carrier concentration?
 - d. Now, assume that a voltage of 5V is placed across two opposing sides if this material. What are the values of the hole current and the electron current?
 - e. Instead of a voltage across this material, this silicon cube is exposed to light and undergoes photogeneration. Determine the diffusion length of the minority carrier in this material, assuming low-level injection.
- 4. A silicon p-n junction with a cross sectional area of 10^{-4} cm² has been doped on the p-type side with N_A = 10^{17} cm⁻³ and on the n-type side with N_D = $3x10^{17}$ cm⁻³.
 - a. Determine the built-in potential.
 - b. Determine the equilibrium width of the depletion region.
 - c. Determine the maximum electric field in the p-n junction in equilibrium.
 - d. Determine the zero-bias junction capacitance.
 - e. Determine the junction capacitance if the junction is reverse biased with 3V.

For Parts f-h, a forward bias of 0.1V has been applied to the p-n junction diode.

- f. Determine the width of the depletion region under bias.
- g. Determine the maximum electric field under bias.
- h. Determine the total current that flows under bias.

- 5. A silicon p-n junction has been doped on the p-type side with $N_A = 10^{17} \text{cm}^{-3}$ and on the n-type side with $N_D = 10^{18} \text{cm}^{-3}$. Draw the following to scale. Be sure to label all important points and intercepts (exact values are not needed, but expressions are required).
 - a. Band diagram in equilibrium.
 - b. Charge density in equilibrium verses position along the p-n junction.
 - c. Electric field in equilibrium verses position along the p-n junction.
 - d. Repeat Parts a-c for a forward biased p-n junction. Emphasize the differences from the equilibrium conditions.
 - e. Repeat Parts a-c for a reverse biased p-n junction. Emphasize the differences from the equilibrium conditions.